

RECEIVED  
CENTRAL FAX CENTER

MAY 27 2004

OFFICIAL

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Potts

Docket No: TI-27832

Serial No: 10/055,445

Examiner: Geyer, Scott B.

Filed: 1/23/2002

Art Unit: 2829

For: SEMICONDUCTOR WAFER WITH GROUPED INTEGRATED CIRCUIT  
DIE HAVING INTER-DIE CONNECTIONS FOR GROUP TESTING

AMENDMENT UNDER 37 C.F.R. § 1.115

Assistant Commissioner For Patents  
Washington, DC 20231

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being  
transmitted by facsimile to the U.S. Patent and Trademark  
Office at 703-872-9306 on 5-27-04:

*Terrie Chambers*  
Terrie Chambers

Dear Sir:

Responsive to the Office Action mailed December 31, 2003 in connection with  
the above identified application, Applicants respectfully submit the following  
amendments and remarks.